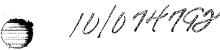
5





P17120

ABSTRACT

A first conductive pattern (3) is transfer-printed on a ceramic substrate (2) using an intaglio plate made of a flexible resin, and a first insulation layer (21) is formed thereon, and a second conductive pattern (4) is formed on it. The two conductive patterns (3, 4) are coupled by means of a via (11).